

## ZPMV2.E522364 - Wiring, Printed - Component

## Wiring, Printed - Component

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E522364

Type	Cond Width		Cond Thk mic(mil)	SS/ DS/ DSO	Area Diam mm(in)	Solder Limits °C sec	Assembly			Oper Temp °C	Flame Class	Meets UL796 DSR	C T I
	Min mm(in)	Edge mm(in)					Solder Process (IPC) °C Cycles	Temp °C	Flame Class				
<b>Multilayer printed wiring boards</b>													
<b>LB-3</b>	0.075 (0.003)	0.075 (0.003)	12 (0.47) Int:68	DS	76.2 (3)	288	20	-	-	130	V-0	All	*
<b>Single layer printed wiring boards</b>													
<b>LB-1</b>	0.1 (0.004)	0.1 (0.004)	17 (0.67)	DS	50.8 (2)	288	20	-	-	130	V-0	All	*
<b>LB-2</b>	0.075 (0.003)	0.075 (0.003)	12 (0.47)	DS	76.2 (3)	288	20	-	-	130	V-0	All	*

\* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name, type designation. May be followed by a suffix to denote factory identification or burning test classification.

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